ROYALOHM

SPECIFICATION FOR APPROVAL

TRELIK

Description: Thick Film Chip Resistors (Terminal Lead Free)

Royalohm Part no.:

25121WxxxxxT4E (RMC 1W (2512) +/-1%, 5% & Jumper)

Approved by					

Parts corresponding to RoHS Compliant: 2005-Apr.-1

Royal Electronic Factory (Thailand) Co., Ltd.

20/1-2 Moo 2 Klong-Na, Muang Chachoengsao 24000, Thailand

Tel: +66-38-822404-8

Fax: +66 38-981190 / 823765

E-mail Address: Export sales: Export@royalohm.com

Local sales: Local@royalohm.com

http://www.royalohm.com

P.O. Box 251 Klongchan, Bangkok 10240, Thailand

Approved	Checked	Prepared
Mr. Jack Lin	Mr. S. Polthanasan	Ms. P. Supatta

Issue Date: 2015/01/10

CHANGE NOTIFICATION HISTORY							
Version	Date of Version	History	Remark				
1	2015/01/10	1. Chip series (2512) @ 1W					
		2. Resistance tolerance: ±1%, ±5% & Jumper					
		3. Temperature coefficient 1Ω - 10Ω : ± 400 PPM/°C					
		11Ω - 100Ω : ± 200 PPM/°C					
		>100Ω: ±100 PPM/°C					
		+					
		+					
		+					
		+					
		+					
		+					
		+					
		+					
		-					
		ļ					

Customer: TRELIK Part. No.: 25121WxxxxxT4E

1. Scope:

This specification for approval relates to Thick Film Chip Resistors (Terminal Lead Free) manufactured by ROYALOHM's specifications.

2. Type designation:

The type designation shall be in the following form:

Ex.

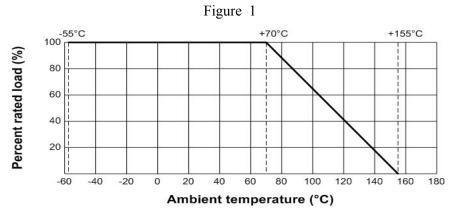
Type	Power Rating	Power Rating Resistance tolerance	
RMC 2512	1W	F, J	1ΚΩ

3. Ratings:

Туре	RMC 2512
Power Rating	1W
Rated Current (Jumper)	2.5A
Max. Overload Current (Jumper)	10A
Max. Working Voltage	200 V
Max. Overload Voltage	500 V
Dielectric Withstanding Voltage	500 V
Temperature Range	-55°C ~ +155°C
Ambient Temperature	70 ℃

3.1 Power rating:

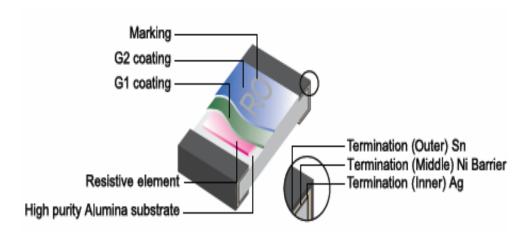
Resistors shall have a power rating based on continuous load operation at an ambient temperature of 70 $^\circ\! C$. For temperature in excess of 70 $^\circ\! C$, The load shall be derate as shown in figure 1.



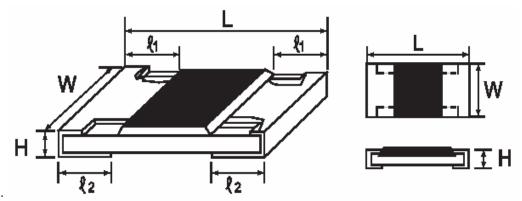
3.2 Nominal Resistance

Effective figures of nominal resistance shall be in accordance with E-24 and E-96 series. E-96 series for 1% and E-24 series for 2%, 5%.

4. Construction:



5. Power rating and dimensions



Dimension:

	Dimension (mm)					
Туре	$L \pm 0.10$	$W \pm 0.15$	$H \pm 0.10$	ℓ1± 0.25	$\ell 2 \pm 0.20$	
RMC 2512	6.35	3.20	0.55	0.60	0.50	

Power Rating:

Туре	Power Rating at 70 °C	Tolerance %	Resistance Range	Standard Series
RMC 2512		Jumper	< 50mΩ	
	1W	± 1	$10\Omega \sim 1M\Omega$	E-96
		± 5	$1\Omega \sim 10 M\Omega$	E-24

6. Marking:

- 6.1 Resistors
 - A. Marking for E-96 series in 2512 size: 4 Digits

*The first 3 digits are singnificant figures of resistance and the 4th digit denoted number of zeros.

Ex. 1003 100K Ω

*For ohmic values below 100 Ω , letter"R" is for decimal point.

Ex. 1R80 1.8Ω

B. Marking for E-24 series in 2512 size: 3 Digits

*The first 2 digits are singnificant figures of resistance and the 3rd digit denoted number of zeros.

Ex. 102 1KΩ

*For ohmic values below 10 Ω , letter"R" is for decimal point.

Ex. R68 0.68 Ω

6.2 Labels

Label shall be marked with the following item:

- A. Nominal Resistance and Resistance Tolerance
- B. Power Rating and Size
- C. Quantity
- D. Part No.
- E. P.O.No.
- F. Lot No.

Ex.

ROYALOHM Chip Resistors						
Resistance:	1K	Ω	± 5%			
Wattage:	1W		Size: 2512			
Quantity:	4000	Pcs.	100 PPM			
Part No.:						
Lot No. :	82572	23 2512	1WJ0102T4E			

Remark: Label is 1K, value is $1K\Omega$, marking is 102

CONFIDENTIAL DOCUMENT

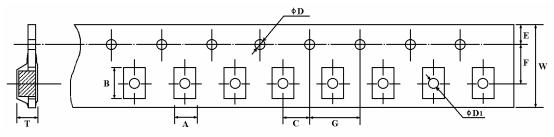
Thick Film Chip Resistors (Terminal Lead Free)						
7. Performano	ce specification :					
Characteristics	Limits	Test Methods (JIS C 5201-1)				
*Insulation resistance	1,000 M Ω or more	Apply 500V DC between protective coating and termination for 1 min, then measure (Sub-clause 4.6)				
*Dielectric withstanding voltage	No evidence of flashover mechanical damage, arcing or insulation break down	Apply 500V AC between protective coating and termination for 1 minute (Sub-clause 4.7) Natural resistance change per temp.				
Temperature coefficient	1Ω -10Ω: ± 400 PPM/°C 11Ω -100Ω: ± 200 PPM/°C >100Ω: ± 100 PPM/°C	degree centigrade. R2-R1 x 10 ⁶ (PPM/°C) R1(t2-t1) R1: Resistance value at room temperature (t1) R2: Resistance value at room temp. plus 100 °C (t2) (Sub-clause 4.8)				
Short time overload	Resistance change rate is $\pm 5\% (2.0\% + 0.1 \Omega)$ Max. $\pm 1\% (1.0\% + 0.1 \Omega)$ Max.	Permanent resistance change after the application of a potential of 2.5 times RCWV for 5 seconds (Sub-clause 4.13)				
*Solderability	95 % coverage Min.	Test temperature of solder : 245 ± 3°C Dipping them solder : 2-3 seconds (Sub-clause 4.17)				
Soldering temp. reference	Electrical characteristics shall be satisfied. Without distinct deformation in appearance. (95 % coverage Min.)	Wave soldering condition: (2 cycles Max.) Pre-heat: 100 ~ 120 °C, 30 ± 5 sec. Suggestion solder temp.: 235 ~ 255 °C, 10 sec. (Max.) Peak temp.: 260 °C Reflow soldering condition: (2 cycles Max.) Pre-heat: 150 ~ 180 °C, 90 ~ 120 sec. Suggestion solder temp.: 235 ~ 255 °C, 20 ~ 40 sec. Peak temp.: 260 °C Peak: 260 °C Peak: 260 °C Peak: 260 °C Peak: 260 °C Pre Heating Zone Heating time Temperature profile for avaluation Hand soldering condition: The soldering iron tip temperature should be less than 300 °C and maximum contract time should be 5 sec.				

	Thick Film Chip Resi	stors (Term	inal Lead Free)			
7. Performano	ce specification:					
Characteristics	Limits	Test Methods				
Characteristics	Limits	(JIS C 5201-1)				
Soldering	Resistance change rate is:	Dip the resist	tor into a solder bath h	naving		
Heat	$\pm (1\% + 0.05\Omega)$ Max.	a temperature	e of 260°C±3°C and h	old it for 10±1		
		seconds.				
		(Sub-clause 4	4.18)			
		Resistance cl	nange after continuous	3		
		5 cycles for o	duty cycle specified be	elow:		
	Resistance change rate is	Step	Temperature	Time		
Temperature	$\pm 5\% (1.0\% + 0.05 \Omega)$ Max.	1	-55°C ± 3°C	30 mins		
cycling	$\pm 1\% (0.5\% + 0.05 \Omega)$ Max.	2	Room temp.	10~15 mins		
		3	+155°C ± 2°C	30 mins		
		4	Room temp.	10~15 mins		
		(Sub-clause 4	4.19)			
		Resistance cl	nange after 1,000 hour	S		
Load life in	Resistance change rate is	(1.5 hours "o	n", 0.5 hour "off") at	RCWV		
humidity	$\pm 5\% (3.0\% + 0.1 \Omega)$ Max.	in a humidity	chamber controlled a	t		
	$\pm 1\% (1.0\% + 0.1 \Omega)$ Max.	$40^{\circ}\text{C} \pm 2^{\circ}\text{C}$ a	and 90 to 95 % relative	humidity		
		(Sub-clause 4	4.24.2.1)			
	Resistance change rate is	Permanent re	esistance change after	1,000 hours		
Load Life	$\pm 5\% (3.0\% + 0.1 \Omega)$ Max.	operating at l	RCWV, with duty cyc	le of		
	$\pm 1\% (1.0\% + 0.1 \Omega)$ Max.	(1.5 hours"or	n", 0.5 hour"off") at 70	0° C ± 2° C ambient		
		(Sub-clause 4.25.1)				
Terminal	Resistance change rate is	Twist of Test Board :				
bending	$\pm (1.0\% + 0.05 \Omega)$ Max.	Y/X = 5/90 n	nm for 10 seconds			
		(Sub-clause 4	4.33)			

The resistors of 0Ω only can do the characteristic noted of *

8. Packing specification:

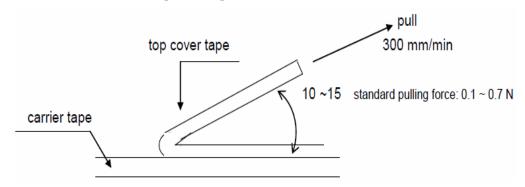
* Taping Dimension (mm)



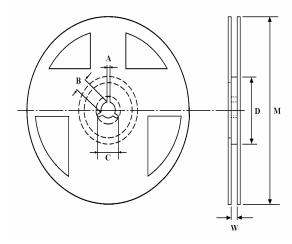
Туре	A ±0.2	B ±0.2	C ±0.05	φ D+0.1 -0	E ±0.1	F ±0.05	G ±0.1	W ±0.2	φ D1+0.1 -0	T ± 0.1
2512	3.5	6.7	2.0	1.5	1.75	5.5	4.0	12	1.5	1.0

* Peeling Strength of Top Cover Tape

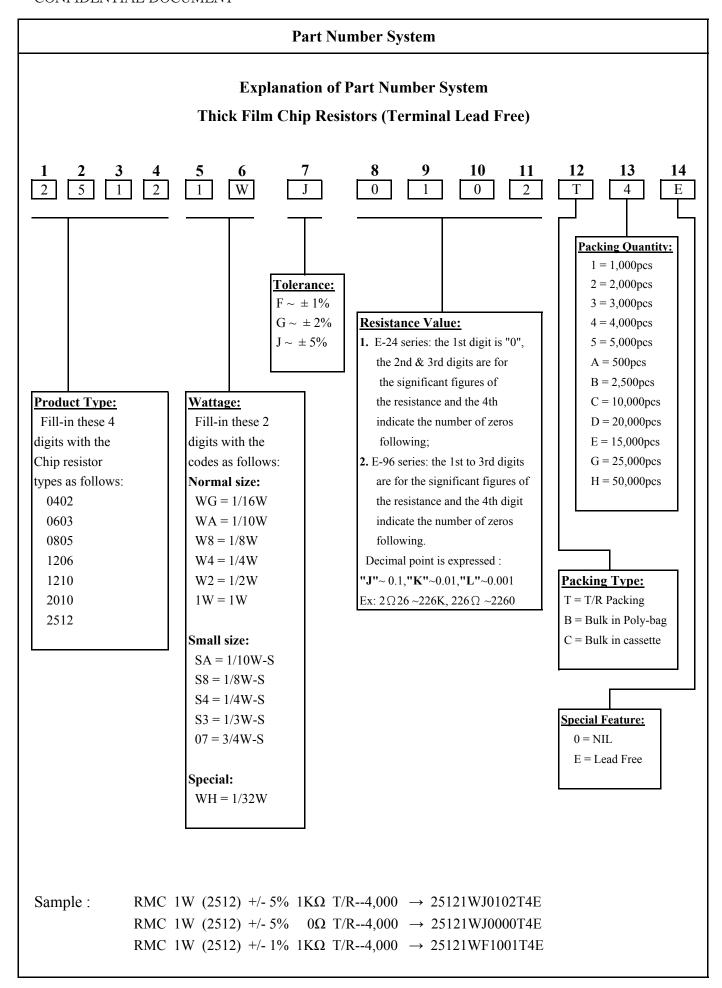
Test Condition: 0.1 to 0.7 N at a peel-off speed of 300 mm / min.



* Reel Dimension (mm)



Туре	Quantity Per Reel	$A \pm 0.5$	B ± 0.5	$C \pm 0.5$	D ± 1	$M \pm 2$	W ± 1
2512	4000 Pcs. Reel	2	13	21	60	178	13.8



Environment Related Substance

This product complies to EU RoHS directive, EU PAHs directive, EU PFOS directive and Halogen free.

Ozone layer depleting substances.

Ozone depleting substances are not used in our manufacturing process of this product.

This product is not manufactured using Chloro fluorocarbons (CFCs), Hydrochlorofluorocarbons (HCFCs),

Hydrobromofluorocarbons (HBFCs) or other ozone depleting substances in any phase of the manufacturing process.

Storage Condition

The performance of these products, including the solderability, is guaranteed for a year from the date of arrival at your company, provided that they remain packed as they were when delivered and stored at a temperature of $25^{\circ}\text{C} \pm 5^{\circ}\text{C}$ and a relative humidity of $60\%\text{RH} \pm 10\%\text{RH}$

Even within the above guarantee periods, do not store these products in the following conditions. Otherwise, their electrical performance and/or solderability may be deteriorated, and the packaging materials (e.g. taping materials) may be deformed or deteriorated, resulting in mounting failures.

- 1. In salty air or in air with a high concentration of corrosive gas, such as Cl₂, H₂S, NH₃, SO₂, or NO₂
- 2. In direct sunlight